COMPLIANT

HALOGEN FREE

GREEN

(5-2008)



Vishay Semiconductors

High Power Infrared Emitting Diode, 850 nm, Surface Emitter Technology



LINKS TO ADDITIONAL RESOURCES



DESCRIPTION

As part of the <u>SurfLightTM</u> portfolio, the VSMA1085600 is an infrared, 850 nm emitting diode. It features a double stack emitter chip for highest radiant power. The 42 mil chip size allows 1.5 A DC operation and supports pulsed currents up to 5.0 A.

FEATURES

- · Package type: surface-mount
- · Package form: high power SMD with lens
- Dimensions (L x W x H in mm): 3.4 x 3.4 x 1.8
- Centroid wavelength: λ_{centroid} = 850 nm
- Angle of half intensity: $\varphi = \pm 60^{\circ}$
- Designed for high drive currents: up to 1.5 A (DC) and up to 5 A (pulsed)
- Low thermal resistance: 6 K/W < R_{thJSP} < 9 K/W
- ESD: up to 5 kV (according to ANSI / ESDA / JEDEC® JS-001)
- Floor life: 168 h, MSL 3, according to J-STD-020
- · Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

APPLICATIONS

- · Driver and occupant monitoring
- Eve tracking
- · Safety and security, CCTV

PRODUCT SUMMARY					
COMPONENT	I_e (mW/sr) at I_F = 1.0 A	φ (°)	$\lambda_{\mathbf{p}}$ (nm)	$\lambda_{centroid}$ (nm)	t _r (ns)
VSMA1085600	490	± 60	860	850	10

Note

• Test conditions see table "Basic Characteristics"

ORDERING INFORMATION						
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM			
VSMA1085600	Tape and reel	MOQ: 600 pcs, 600 pcs/reel	High power with lens			

Note

• MOQ: minimum order quantity



www.vishay.com

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ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT		
Reverse voltage		V_{R}	5	V		
Forward current		I _F	1.5	Α		
Surge forward current	t _p = 100 μs	I _{FSM}	5	А		
Power dissipation		P_V	5.33	W		
Junction temperature		Tj	145	°C		
Ambient temperature range		T _{amb}	-40 to +125	°C		
Storage temperature range		T _{stg}	-40 to +125	°C		
Soldering temperature	According to Fig. 11, J-STD020E	T_{sd}	260	°C		
Thermal resistance junction to solder point real (1)	JESD 51	R _{thJSP,real}	6 to 9	K/W		
Thermal resistance junction to ambient real	JESD 51	R _{thJA,real}	150	K/W		
ESD sensitivity	According to ANSI / ESDA / JEDEC JS-001	V _{ESD}	5	kV		

Note

⁽¹⁾ Thermal resistance junction to solder point real has been measured with the part mounted on an ideal heatsink and the optical output power has been deducted from the total electrical power dissipation

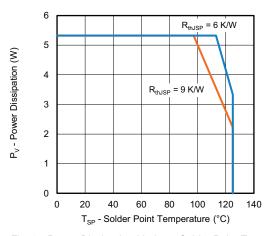


Fig. 1 - Power Dissipation Limit vs. Solder Point Temperature

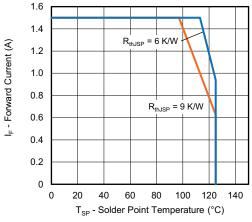


Fig. 2 - Forward Current Limit vs. Solder Point Temperature



BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 0.35 \text{ A}, t_p = 10 \text{ ms}$	V _F	2.7	2.95	3.1	V
	$I_F = 1 \text{ A}, t_p = 100 \mu \text{s}$	V _F	2.8	3.1	3.3	V
	$I_F = 1.5 \text{ A}, t_p = 100 \mu\text{s}$	V_{F}	2.9	3.25	3.55	V
	$I_F = 5 \text{ A}, t_p = 100 \mu \text{s}$	V _F	3.2	3.9	4.4	V
Temperature coefficient of V _F	$I_F = 1 \text{ A}, t_p = 200 \mu \text{s}$		-	-2	-	mV/K
Reverse current		I _R	Not designed for reverse operation			μA
Radiant intensity	$I_F = 0.35 \text{ A}, t_p = 10 \text{ ms}$	l _e	135	170	205	mW/sr
	$I_F = 1 \text{ A}, t_p = 100 \mu \text{s}$	l _e	375	490	600	mW/sr
	$I_F = 1.5 \text{ A}, t_p = 100 \mu\text{s}$	I _e	515	715	915	mW/sr
	$I_F = 5 \text{ A}, t_p = 100 \mu \text{s}$	l _e	1550	2200	2850	mW/sr
Radiant power	$I_F = 1 \text{ A}, t_p = 100 \mu \text{s}$	φ _e	-	1425	-	mW
	$I_F = 1.5 \text{ A}, t_p = 100 \mu\text{s}$	фe	-	2100	-	mW
Temperature coefficient of ϕ	$I_F = 1 \text{ A}, t_p = 200 \mu \text{s}$	TK_{ϕ}	-	-0.15	-	%/K
Angle of half intensity		φ	-	± 60	-	0
Peak wavelength	$I_F = 1 \text{ A}, t_p = 300 \mu \text{s}$	λρ	-	860	-	nm
Centroid wavelength	$I_F = 1 \text{ A}, t_p = 300 \mu s$	$\lambda_{centroid}$	-	850	-	nm
Spectral bandwidth	$I_F = 1 \text{ A}, t_p = 300 \mu \text{s}$	Δλ	-	30	-	nm
Temperature coefficient of λ_p	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	TK_{\lambdap}	-	0.25	-	nm/K
Rise time	I _F = 1 A	t _r	-	10	-	ns
Fall time	I _F = 1 A	t _f	-	15	-	ns

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

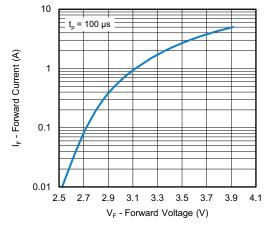


Fig. 3 - Forward Current vs. Forward Voltage

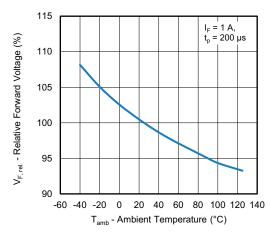


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

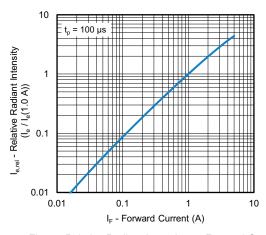


Fig. 5 - Relative Radiant Intensity vs. Forward Current

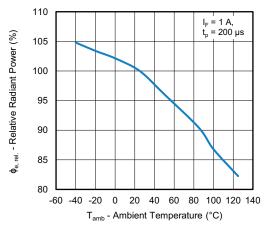


Fig. 6 - Relative Radiant Power vs. Ambient Temperature

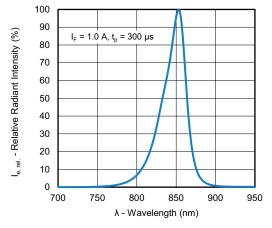


Fig. 7 - Relative Radiant Intensity vs. Wavelength

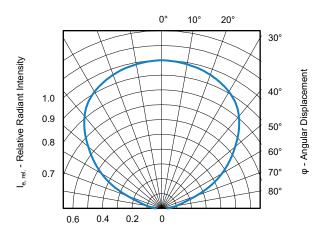


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

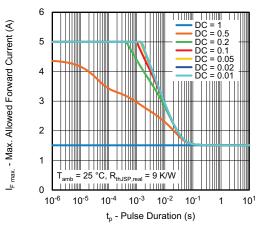


Fig. 9 - Max. Allowed Forward Current vs. Pulse Duration

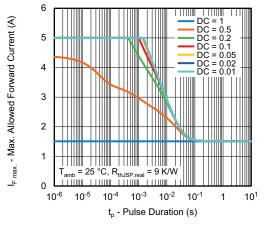
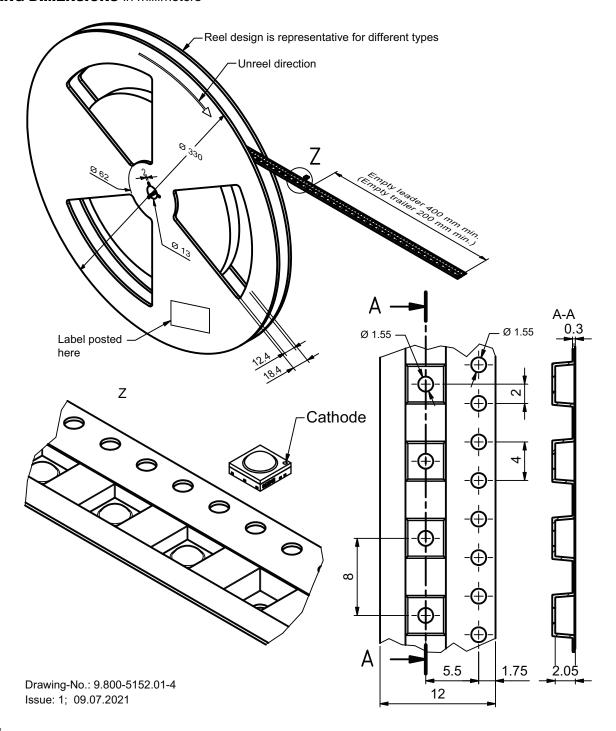


Fig. 10 - Max. Allowed Forward Current vs. Pulse Duration



TAPING DIMENSIONS in millimeters

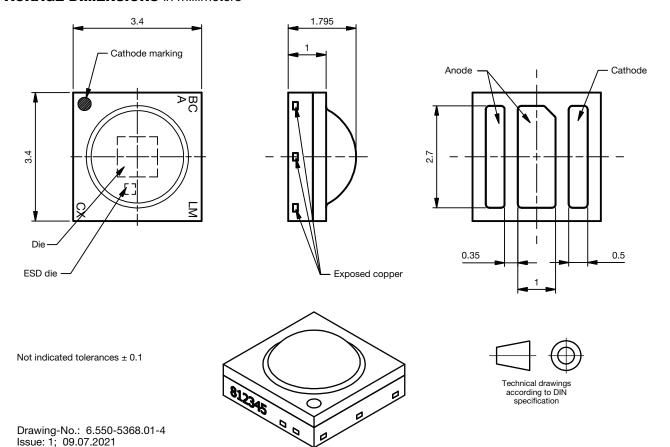


Notes

- Empty component pockets sealed with top cover tape
- 7 inch reel 600 pieces per reel
- The maximum number of consecutive missing lamps is two
- In accordance with ANSI / EIA 481-1-A-1994 specifications



PACKAGE DIMENSIONS in millimeters

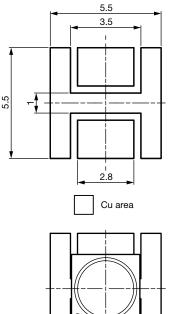


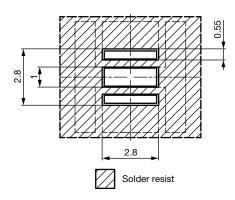
Notes

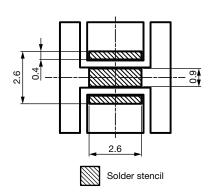
- Tolerance is ± 0.10 mm (0.004") unless otherwise noted
- · Specifications are subject to change without notice



RECOMMENDED FOOTPRINT







Cathode marking Component location on pad

Drawing-No.: 6.550-5366.9-3 Issue: 1; 09.07.2021

SOLDER PROFILE

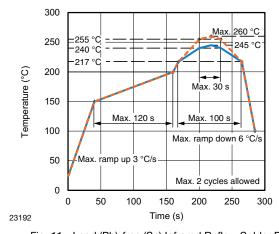


Fig. 11 - Lead (Pb)-free (Sn) Infrared Reflow Solder Profile According to J-STD020E for Surface-Mount Components

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 3, according to J-STD-020B

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-033D or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.



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Vishay

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